

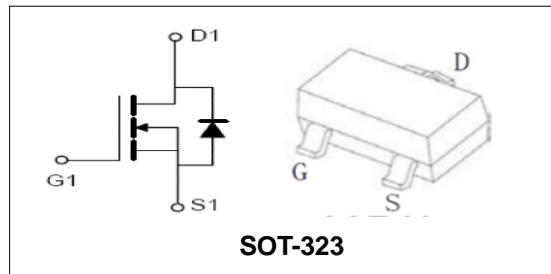
20V/2.1A N-Channel Junction Power MOSFET
Features

- TrenchFET Power MOSFET

BVDSS	20	V
ID	2.1	A
RDSON@VGS=4.5V	59	mΩ
RDSON@VGS=2.5V	70	mΩ

Applications

- Load Switch for Portable Devices
- DC/DC Converter


Order Information

Product	Package	Marking	Reel Size	Reel	Carton
PT2202	SOT-323	2202	7inch	3000PCS	180000PCS

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V _{(BR)DSS}	Drain-Source Breakdown Voltage	20	V
V _{GS}	Gate-Source Voltage	±8	V
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	TA =25°C	0.6
Mounted on Large Heat Sink			
I _{DM}	Pulse Drain Current Tested (Sillicon Limit) (Note1)	TA =25°C	12
I _D	Continuous Drain current	TA =25°C	2.1
P _D	Maximum Power Dissipation	TA =25°C	0.2
R _{θJA}	Thermal Resistance Junction-to-Ambient (Note2)		625 °C/W

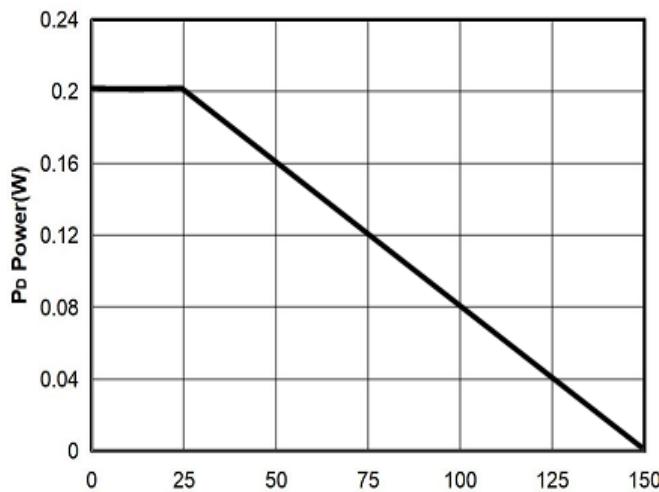
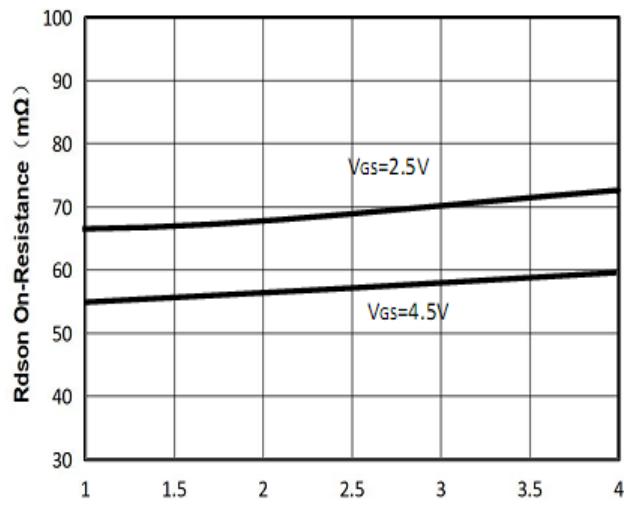
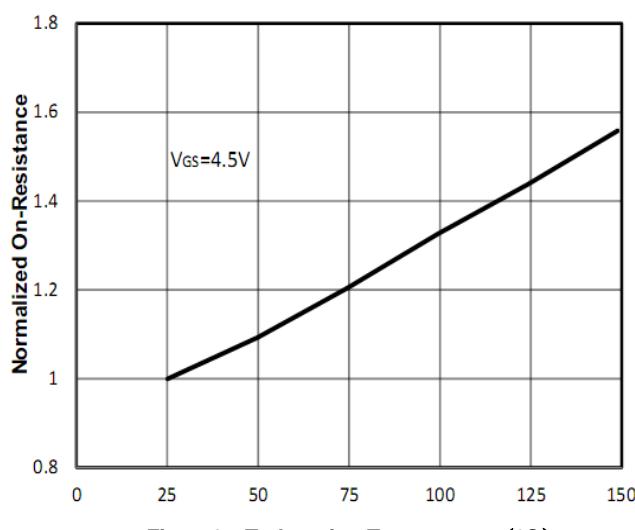
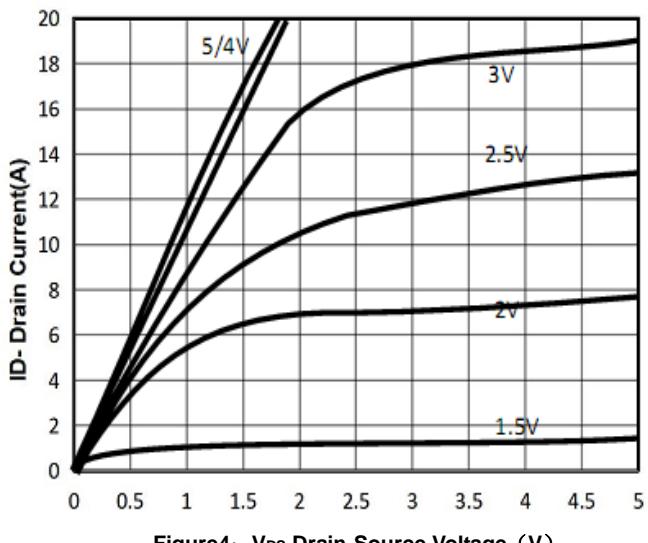
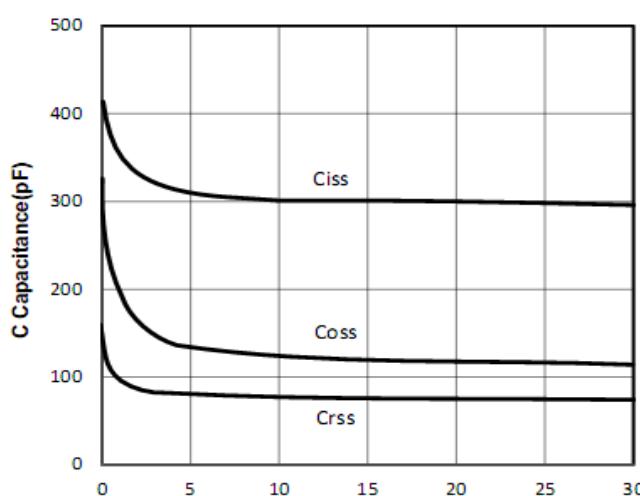
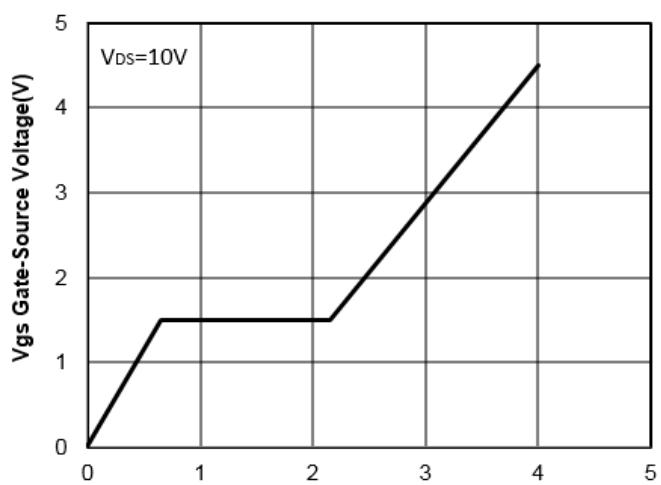


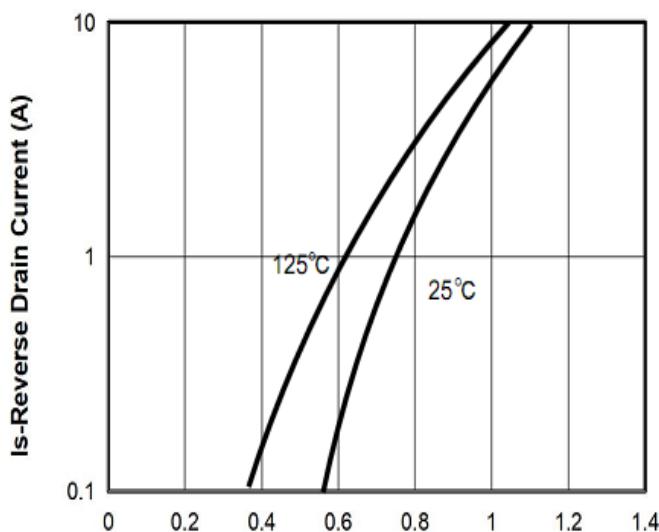
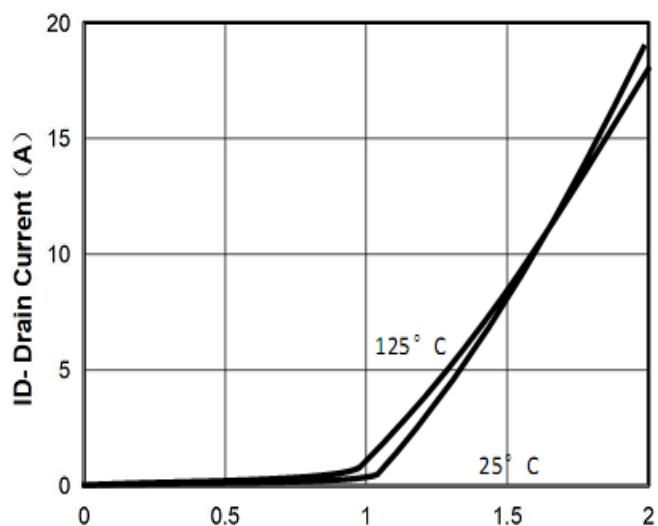
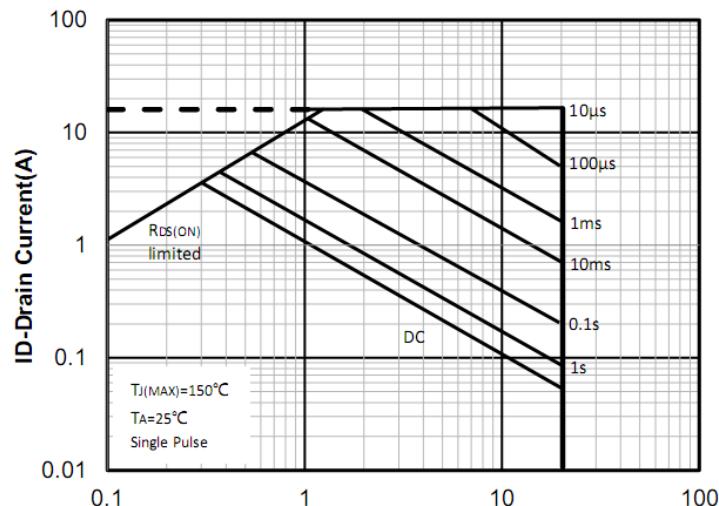
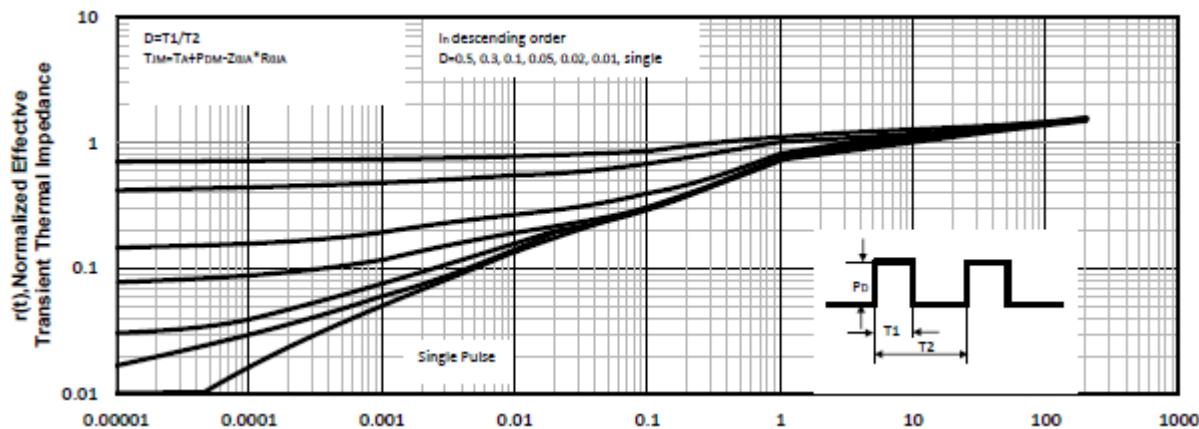
20V/2.1A N-Channel Junction Power MOSFET

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$VGS=0V$ $ID=10\mu A$	20	--	--	V
I_{DSS}	Zero Gate Voltage Drain current	$VDS=20V$, $VGS=0V$	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	$VGS=\pm 8V$, $VDS=0V$	--	--	± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$VDS=VGS$, $ID=50\mu A$	0.65	0.95	1.2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	$VGS=4.5V$, $ID=3.6A$	--	59	68	mΩ
		$VGS=2.5V$, $ID=3.1A$	--	70	115	
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note4)						
C_{iss}	Input Capacitance	$VDS=10V$, $VGS=0V$, $F=1MHz$	--	300	--	pF
C_{oss}	Output Capacitance		--	120	--	pF
C_{rss}	Reverse Transfer Capacitance		--	80	--	pF
Q_g	Total Gate Charge	$VDS=10V$, $ID=3.6A$,	--	4	--	nC
Q_{gs}	Gate-Source Charge		--	0.65	--	nC
Q_{gd}	Gate-Drain Charge		--	31.5	--	nC
Switching Characteristics (Note4)						
$t_{d(on)}$	Turn-on Delay Time	$VDD=10V$, $RL=5.5\Omega$, $VGS=4.5V$	--	7	--	nS
t_r	Turn-on Rise Time		--	55	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	16	--	nS
t_f	Turn-off Fall Time		--	10	--	nS
Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)						
V_{SD}	Forward on voltage	$IS=0.94A$, $VGS=0V$	--	0.76	1.2	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: pulse width ≤ 300 us, duty cycle $\leq 2\%$.
4. Guranteed by design, not subject to production testing.

20V/2.1A N-Channel Junction Power MOSFET
Typical Characteristics

Figure1: T_j Junction Temperature (°C)

Figure2: I_D Drain Current (A)

Figure3: T_j Junction Temperature (°C)

Figure4: V_{DS} Drain-Source Voltage (V)

Figure5: V_{DS} Drain-Source Voltage (V)

Figure6: Q_g Gate Charge (nC)

20V/2.1A N-Channel Junction Power MOSFET

Figure7: V_{SD} Source-Drain Voltage (V)

Figure8: V_{GS} Gate-Source Voltage (V)

Figure9: V_{DS} Drain -Source Voltage (V)

Figure10: Square Wave Pulse Duration (sec)

**20V/2.1A N-Channel Junction Power MOSFET
Test Circuit and Waveform:**

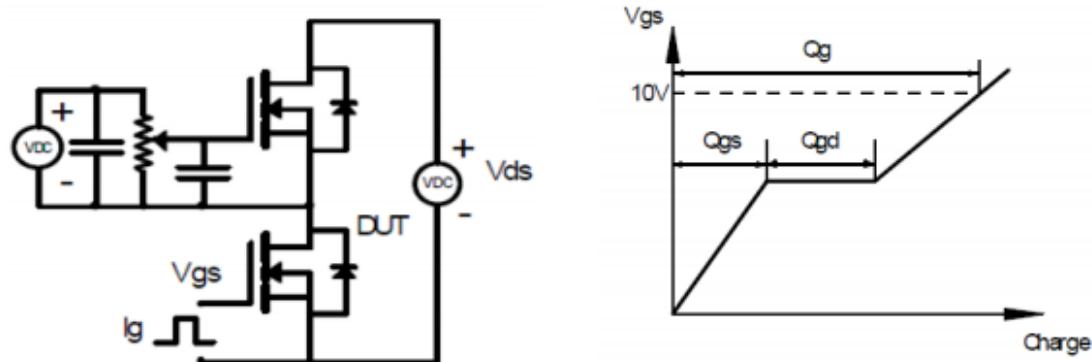


Figure A Gate Charge Test Circuit & Waveforms

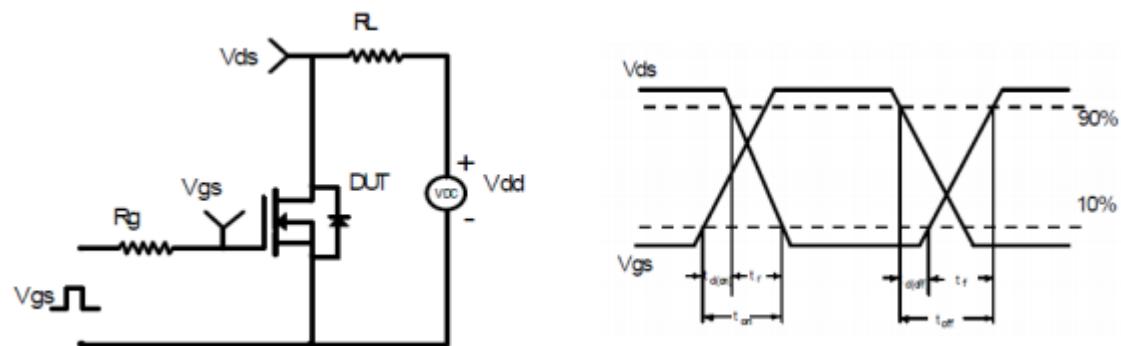


Figure B Switching Test Circuit & Waveforms

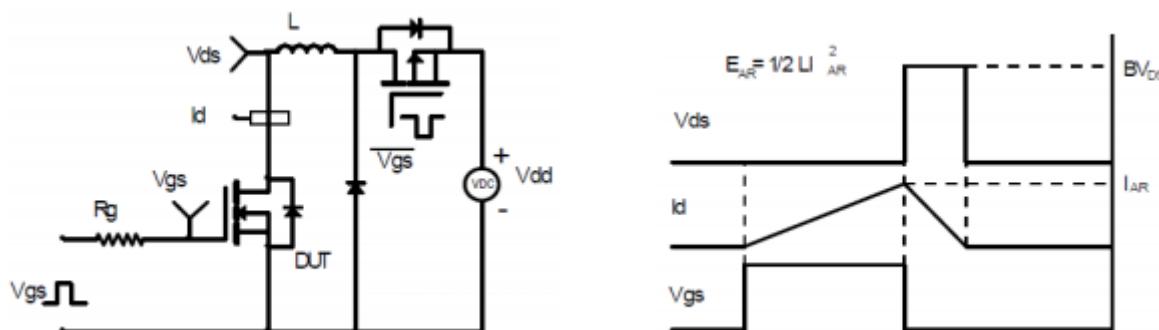
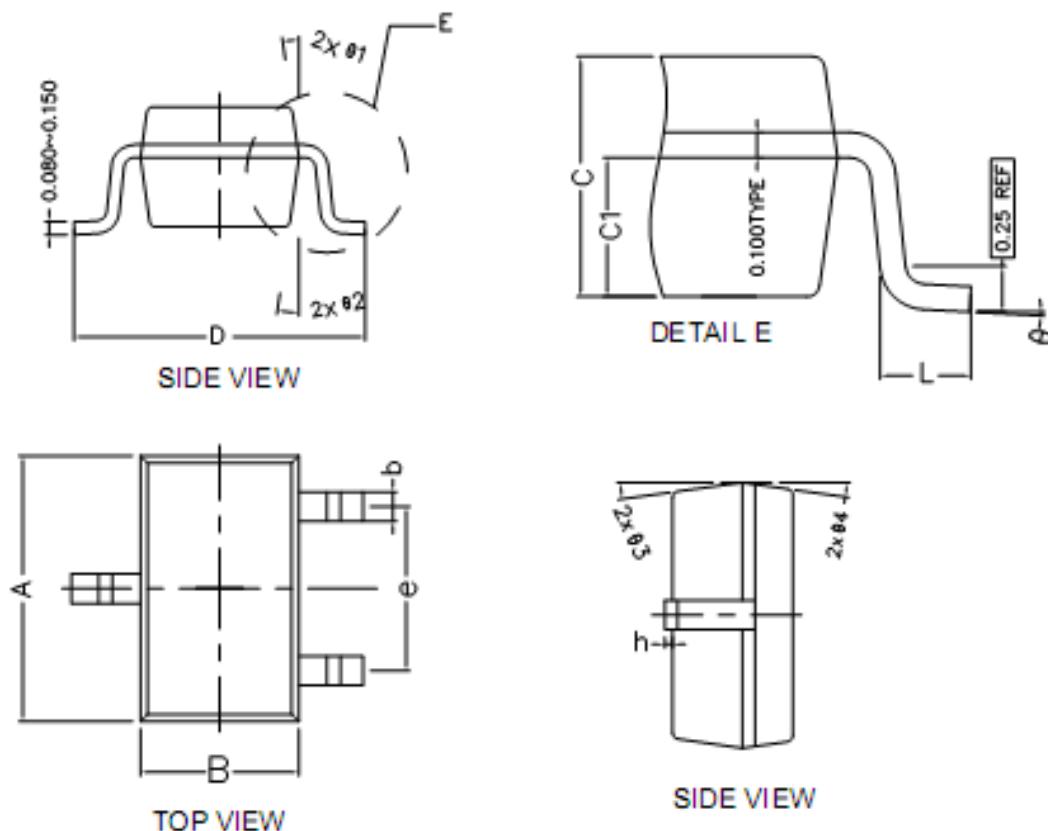


Figure C Unclamped Inductive Switching Circuit & Waveforms

20V/2.1A N-Channel Junction Power MOSFET
SOT-323 Package Outline Dimensions (Units: mm)


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.000	2.100	2.200
B	1.150	1.250	1.350
C	0.900	0.950	1.000
C1	0.500	0.550	0.600
D	2.100	2.300	2.500
L	0.220	0.360	0.500
b	0.200	0.250	0.400
h	0.020	0.050	0.100
e	1.300TYPE		
θ ₁	8° TYPE		
θ ₂	8° TYPE		
θ ₃	8° TYPE		
θ ₄	8° TYPE		
θ	0~8° TYPE		